



# **Product Change Notification**

## **113993 - 00**

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**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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# Product Change Notification

**Change Notification #:** 113993 - 00  
**Change Title:** Boxed Intel® NUC Kit DCCP847DY,  
PCN 113993-00, Product Material, Label,  
Adapter and Label Update  
**Date of Publication:** July 24, 2015

## Key Characteristics of the Change:

Product Material, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Aug 24, 2015
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## Description of Change to the Customer:

The Intel® NUC Kit listed in the product affected table below will have the following change.

- Add BIS certificate label to the FSP power adapter to support shipments to India.
  - Due to insufficient space for the BIS logo on the adapter label, the BIS logo replaces the FCC text on adapter label, and the FCC text label is now on the flank of the adapter.

Example pictures:



**Customer Impact of Change and Recommended Action:**

There is no impact to the Form, Fit, or Function or operation of the Product. The change is only for enabling the use of the power brick in India.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change SA	Post Change SA
BOXDCCP847DYE	925743	G80888-109	G80888-110

**PCN Revision History:**

<b>Date of Revision:</b> July 24, 2015	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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